

## DMTH15H017SPS

150V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
45014	19mΩ @ V <sub>GS</sub> = 10V	61A
150V	22mΩ @ V <sub>GS</sub> = 8V	40A

## Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize  $R_{DS(ON)}$  yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and load switch.

# Applications

- Motor Control
- DC-DC Converters
- Power Management

#### Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications (PowerDI<sup>®</sup>)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

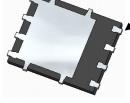
# **Mechanical Data**

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

Site 1:

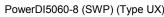


Top View



Bottom View

Site 2:

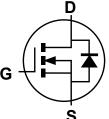


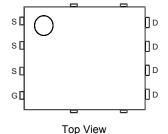
PowerDI5060-8





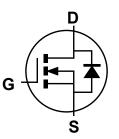
Bottom View



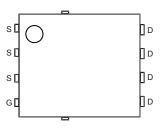


Pin Configuration

Internal Schematic



Internal Schematic



Top View Pin Configuration

Pin1

Pin1

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#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH15H017SPS-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

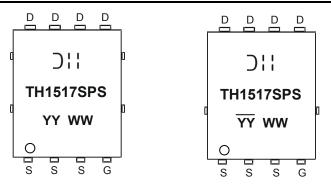
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### Marking Information



 $\bigcirc$  **| |** = Manufacturer's Marking TH1517SPS = Product Type Marking Code YYWW or YYWW = Date Code Marking YY or YY = Last Two Digits of Year (ex: 20 = 2020) WW = Week Code (01 to 53)

#### **Maximum Ratings** (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	150	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current $M_{\rm cont} = 10 M/({\rm Mata} C)$	Steady	T <sub>A</sub> = +25°C		11	А
Continuous Drain Current $V_{GS}$ = 10V (Note 6)	State	T <sub>A</sub> = +100°C	ID	7	A
Continuous Drain Current V <sub>GS</sub> = 10V (Note 7)	Steady	T <sub>C</sub> = +25°C	- I <sub>D</sub>	61	А
	State	T <sub>C</sub> = +100°C		40	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	•	I <sub>DM</sub>	250	А	
Maximum Continuous Body Diode Forward Current		ls	61	А	
Pulsed Body Diode Current (10µs Pulse, Duty Cycle = 1%)			I <sub>SM</sub>	250	Α
Avalanche Current (Note 8), L = 3mH			IAS	14.4	А
Avalanche Energy (Note 8), L = 3mH			E <sub>AS</sub>	311	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	97	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	3.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	47	°C/W
Total Power Dissipation (Note 7)	T <sub>C</sub> = +25°C	PD	107	W
Thermal Resistance, Junction to Case (Note 7)		R <sub>0</sub> JC	1.4	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.



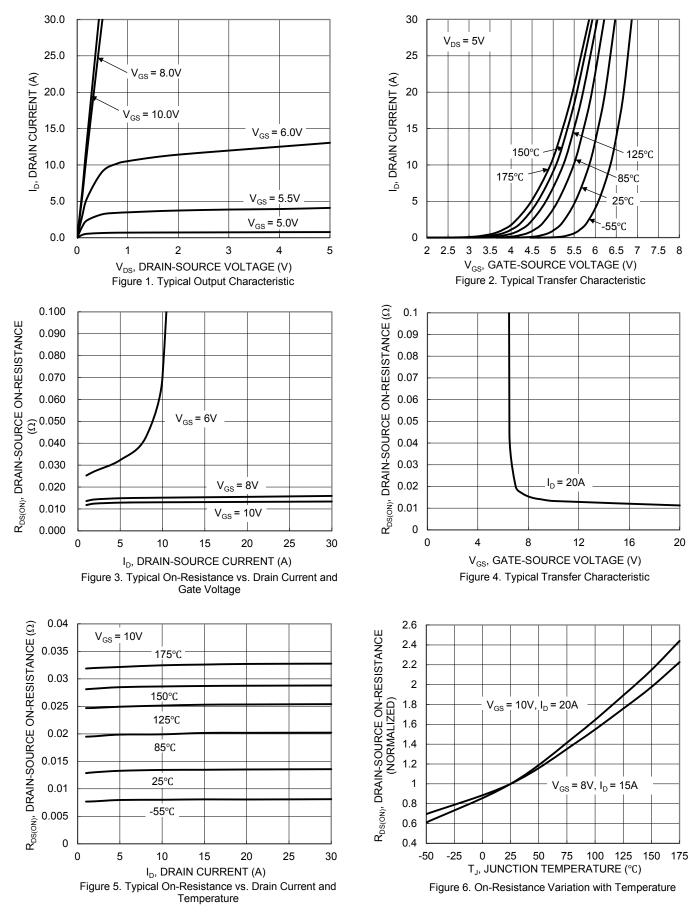
# Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)						-	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	150	—	_	V	$V_{GS} = 0V, I_D = 10mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	1	μA	V <sub>DS</sub> = 120V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	—	±100	nA	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	_	4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	D	—	14	19	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	16	22	11122	V <sub>GS</sub> = 8V, I <sub>D</sub> = 15A	
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2344	_			
Output Capacitance	Coss	_	213	_	pF	V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0V f = 1MHz	
Reverse Transfer Capacitance	Crss	_	6.9	_			
Gate Resistance	Rg		1.8		Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz	
Total Gate Charge	Qg	_	34	_			
Gate-Source Charge	Q <sub>gs</sub>	_	12	_	nC	$V_{DD} = 75V, I_D = 20A,$	
Gate-Drain Charge	Q <sub>gd</sub>		9			V <sub>GS</sub> = 10V	
Turn-On Delay Time	t <sub>D(ON)</sub>		13.2			1	
Turn-On Rise Time	t <sub>R</sub>	_	22.4	_	ns	$V_{DD}$ = 75V, $V_{GS}$ = 10V, $I_D$ = 20A, $R_g$ = 6 $\Omega$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	26.3	_			
Turn-Off Fall Time	t <sub>F</sub>	_	16.1	_	1		
Reverse Recovery Time	t <sub>RR</sub>	_	69	_	ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	196	_	nC	I <sub>F</sub> = 20A, di/dt = 100A/μs	

Notes:9. Short duration pulse test used to minimize self-heating effect.10. Guaranteed by design. Not subject to product testing.

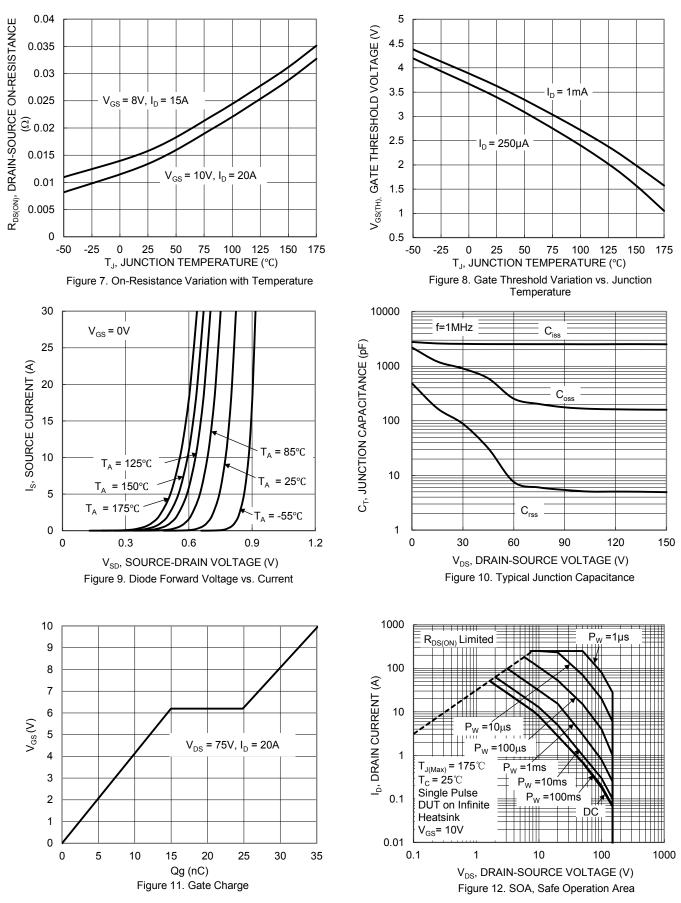


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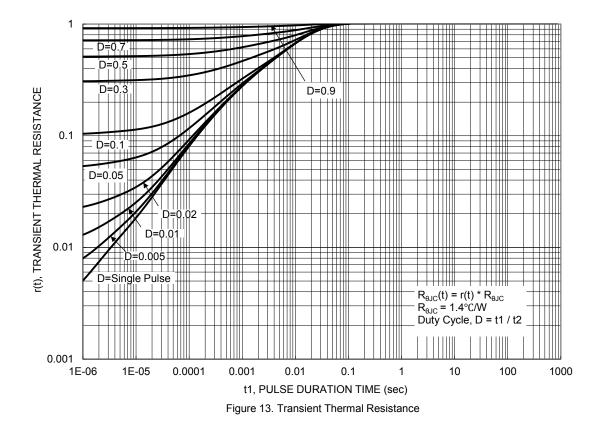


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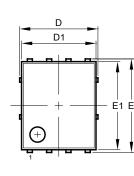


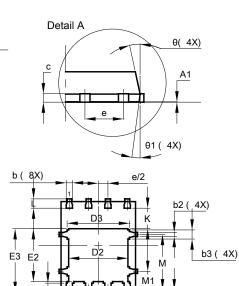
# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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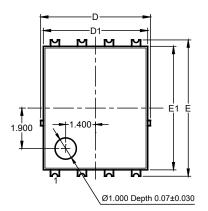




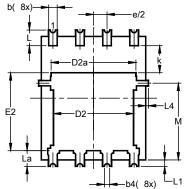
	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
Μ	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
AI	All Dimensions in mm				

Site 2:

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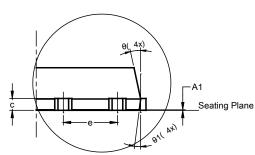


Detail A

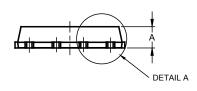


PowerDI5060-8 (SWP) (Type UX)

PowerDI5060-8



DETAIL A



PowerDI5060-8 (SWP)					
(Type UX)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	-		
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	(	).25REF			
С	0.230	0.330	0.277		
D	-	.15 BS(	0		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6.40 BSC				
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	1.27BSC	)		
k	1.05		-		
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0	.050RE	F		
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All	All Dimensions in mm				

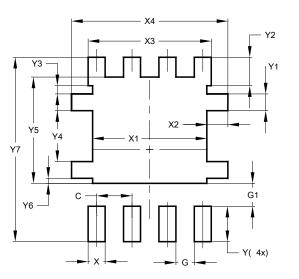
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# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

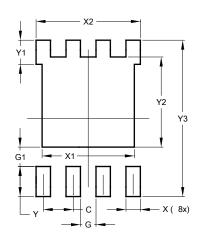


Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

#### PowerDI5060-8 (SWP) (Type UX)

PowerDI5060-8



Value		
(in mm)		
1.270		
0.660		
0.820		
0.610		
4.100		
4.420		
1.270		
1.020		
3.810		
6.610		

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